FLYING ny 國際有限公司 www.flying1688.com

F-TOS-F2181BMR-B-1-HF

SMD Display LED

Part Number	(Chip	Face	Segment Color	
	Material	Source Color	Color		
F-TOS-F2181BMR-B-1-HF	AlGaInP	Ultra-red	Black	White	

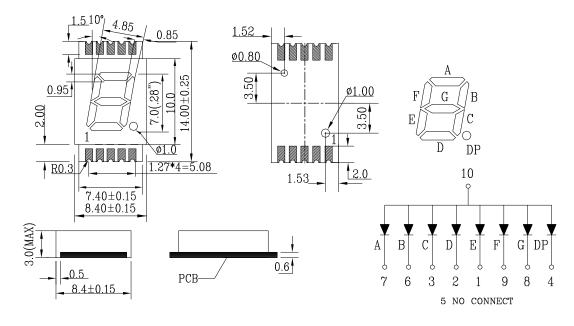
Features

- (0.28") 7.00mm digit height
- · Common anode
- · I.C. compatible
- · Low power consumption
- · RoHS compliant

Applications

- · Audio equipment
- · Instrument panels
- · Digital read out display

Package Dimensions & Internal Circuit Diagram



Notes:

- 1. All dimensions are in millimeters, tolerance: ±0.25; Angle: ±0.1° unless otherwise noted.
- 2. Specifications are subject to change without notice.

REV.: A-1 Prepared by ZG.YANG (23943) Released Date: 2021/12/30 Doc No : GD1912044 Page 1/5

FLYING ny 國際有限公司 Www.flying1688.com

Absolute Maximum Rating @ Ta=25°C

Parameter	Maximum Rating	Unit	
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	80	mA	
Power Dissipation	75	mW	
Continuous Forward Current	20	mA	
Recommend Operating Current	12	mA	
Reverse Voltage	5	V	
Operating Temperature Range	-25°C to +85°C		
Storage Temperature Range	-30°C to +85°C		
Lead-Free Solder Temperature	or 10 Sec		

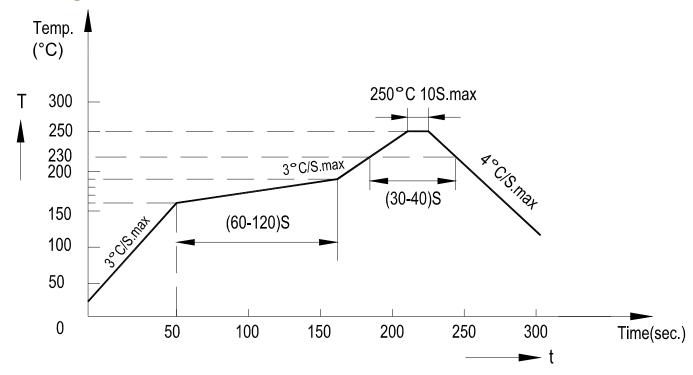
Electrical / Optical Characteristic @ Ta=25°C

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition	Grade
Dominant Wavelength	$\lambda_{\sf d}$	625	630	635	nm	I _F =20mA	
Spectral Line Half-Width	Δλ		15		nm	I _F =20mA	
Forward Voltage	V _F	1.8	2.0	2.3	V	I _F =20mA	
Reverse Current	I _R			10	μA	V _R =5V	
Luminous Intensity Matching Rate	lv-m			2.0:1		I _F =20mA	

REV.: A-1 Prepared by ZG.YANG (23943) Released Date: 2021/12/30 Doc No: GD1912044 Page 2/5

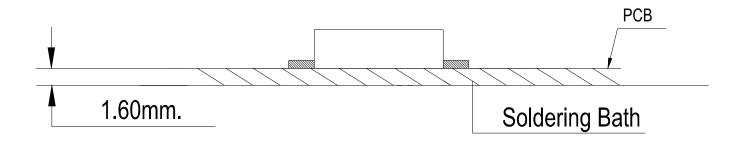
FLYING 汎翊國際有限公司 www.flying1688.com

Soldering Profile



Number of reflow process shall be 2 times or less

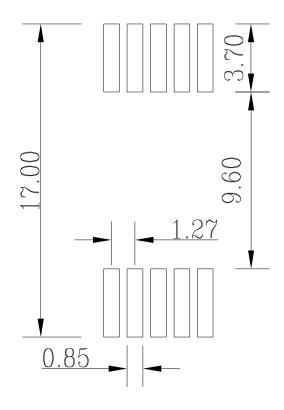
- 1. Manual soldering temperature: Max 320°C for 3 Sec.
- 2. Can be second manual soldering, but must be cooling before second manual soldering, In order to guarantee the soldered area is to be smoothly covered with soldering, can delay the soldering time, but not to exceed 20s every pad, because if that, the pad will be damaged.
- 3. The minimum distance of display seating plan to soldering bath is 1.6mm.
- 4. Don't cause stress to the epoxy resin while it is exposed to high temperature.



REV.: A-1 Prepared by ZG.YANG (23943) Released Date: 2021/12/30 Doc No: GD1912044 Page 3/5

FLYING ny 國際有限公司 www.flying1688.com

Recommended Soldering Pattern and Storage Condition



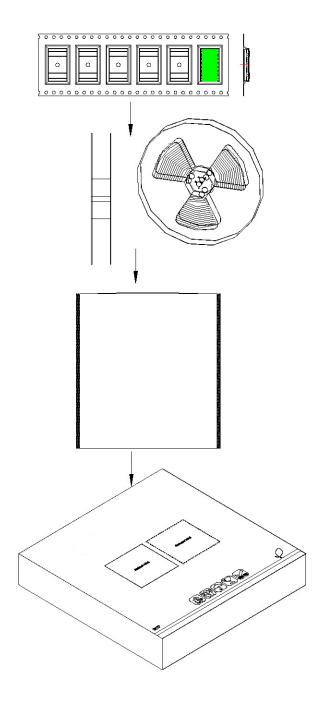
- 1. This part is a moisture sensitive device, According to JEDEC level 4.
- 2. The storage condition of packed: \leq 40° / 90%RH, 12 months or \leq 10%RH.
- 3. The storage condition of unpacked: $\leq 30^{\circ}$ / 60%RH, 72 Hrs or ≤ 10 %RH.

This part can endure ultrasonic cleaning, the solvent hydrocarbon is suitable but isopropyl-alcohol base is not.

REV.: A-1 Prepared by ZG.YANG (23943) Released Date: 2021/12/30 Doc No: GD1912044 Page 4/5

FLYING 汎翊國際有限公司 Www.flying1688.com

Package Description



1000 Pcs/ Roll

1000 Pcs/Box

REV.: A-1 Prepared by ZG.YANG (23943) Released Date: 2021/12/30 Doc No: GD1912044 Page 5/5